

In the December 2007 release of the IPC/ECA J-STD-002C document, an error was made in this document's **Acknowledgement** page.

Michael Lauri of IBM, while indeed a major contributor to this document through the **ECA Soldering Technology Committee**, was incorrectly shown as the Chair of that ECA group. His name and that of his company should instead be incorporated into the membership listings of the two IPC and ECA committees, under the **IPC Component & Wire Solderability Specification Task Group and ECA Soldering Technology Committee** title.

Douglas W. Romm of Texas Instruments Inc. is the actual Chair of the **ECA Soldering Technology Committee** and it is Mr. Romm who should be shown as the Chair of the **ECA Soldering Technology Committee**.

In the printed copies of the IPC/ECA J-STD-002C standard, pen and ink changes, that show the noted modifications, should be made in accordance with your company's document control policies.